



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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### Description

- 125°C maximum total temperature operation
- 3.1mm x 3.1mm x 1.2mm shielded drum core
- Ferrite core material
- Inductance range from 1.0uH to 220uH
- Current range from 1.65 Amps to 0.113 Amps
- Frequency range up to 4MHz



### Applications

- Cellular phones, Digital cameras, CD players, PDA's
- Small LCD displays
- LED driver and LED flash circuits
- Hard disk drives
- Backlighting
- EL panel

### Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (range is application specific)
- Solder reflow temperature: +260°C max. for 10 seconds maximum



### Packaging

- Supplied in tape and reel packaging, 4100 per reel

Part Number	Rated Inductance (µH)	OCL (1) (µH)	Part Marking Designator	I <sub>rms</sub> (2) Amperes	I <sub>sat</sub> (3) Amperes	DCL (2) typ. @ 20°C	K-factor (4)
SD3112-1R0-R	1.0	1.11+/-30%	A	1.30	1.65	0.069	135
SD3112-1R5-R	1.5	1.70+/-30%	B	1.16	1.33	0.099	110
SD3112-2R2-R	2.2	2.4+/-30%	C	0.97	1.12	0.140	92
SD3112-3R3-R	3.3	3.24+/-30%	D	0.90	0.97	0.165	79
SD3112-4R7-R	4.7	4.72+/-30%	E	0.74	0.80	0.246	66
SD3112-6R8-R	6.8	6.47+/-30%	F	0.68	0.68	0.291	56
SD3112-8R2-R	8.2	8.50+/-30%	G	0.57	0.60	0.408	49
SD3112-10R-R	10.0	10.01+/-30%	H	0.55	0.55	0.446	45
SD3112-15R-R	15.0	15.28+/-20%	I	0.45	0.44	0.654	37
SD3112-22R-R	22.0	21.66+/-20%	J	0.37	0.37	0.953	31
SD3112-33R-R	33.0	33.30+/-20%	K	0.30	0.30	1.48	25
SD3112-47R-R	47.0	47.44+/-20%	L	0.270	0.25	1.85	21
SD3112-68R-R	68.0	68.10+/-20%	M	0.228	0.211	2.56	17
SD3112-82R-R	82.0	83.19+/-20%	N	0.213	0.190	2.93	16
SD3112-101-R	100.0	99.8+/-20%	O	0.184	0.174	3.95	14
SD3112-151-R	150.0	149.4+/-20%	P	0.149	0.142	6.01	12
SD3112-221-R	220.0	219.9+/-20%	Q	0.121	0.117	9.12	10

(1) Open Circuit Inductance Test Parameters: 100kHz, 0.1V, 0.0Adc.

(2) I<sub>rms</sub>: DC current for an approximate DT of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.

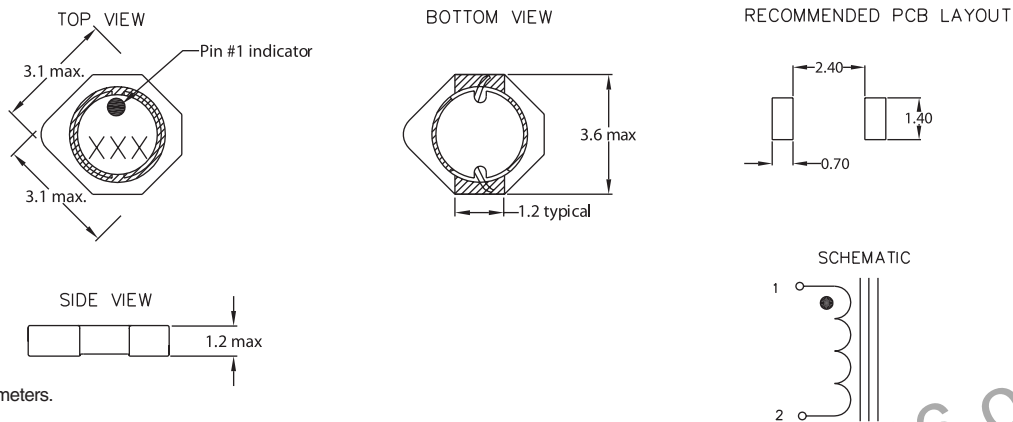
(3) I<sub>sat</sub> Amperes peak for approximately 30% rolloff (@ 20°C)

(4) K-factor: Used to determine B p-p for core loss (see graph).

B p-p = K\*L\*ΔI, B p-p(mT), K: (K factor from table), L: (Inductance in uH), ΔI (Peak to peak ripple current in Amps).



## Mechanical Diagrams

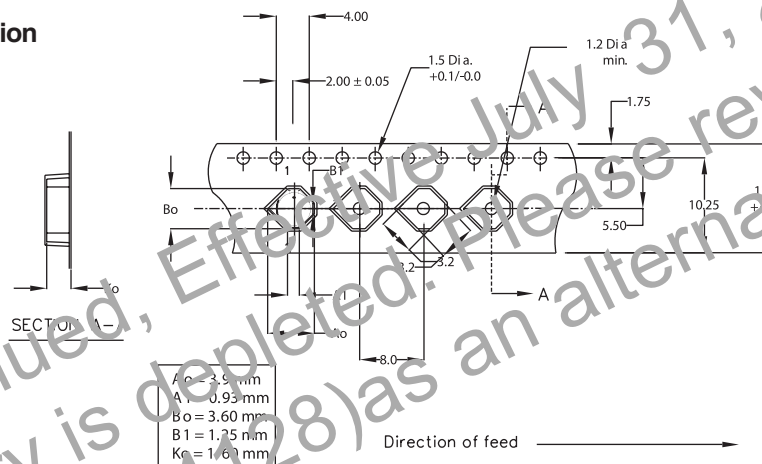


Dimensions are in millimeters.

Part Marking:

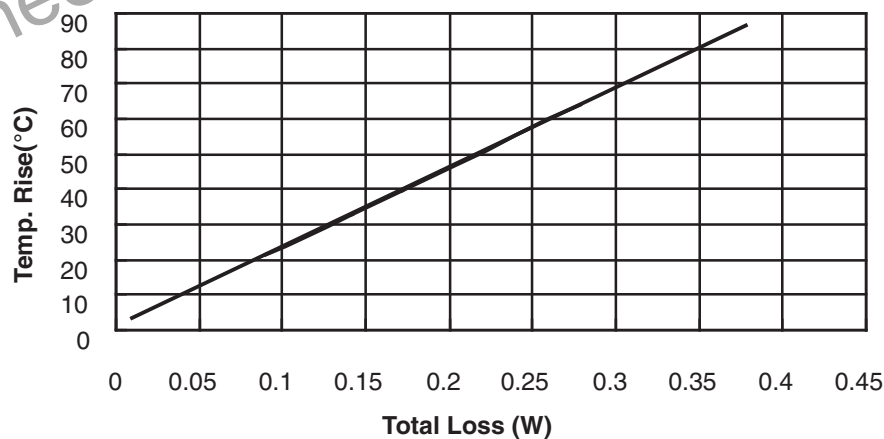
3 Digit Marking: (1st digit: Indicates inductance value per letter in Part Marking Designator); (2nd digit: Bi-weekly production date code); (3rd digit: Last digit of the year produced).

## Packaging Information

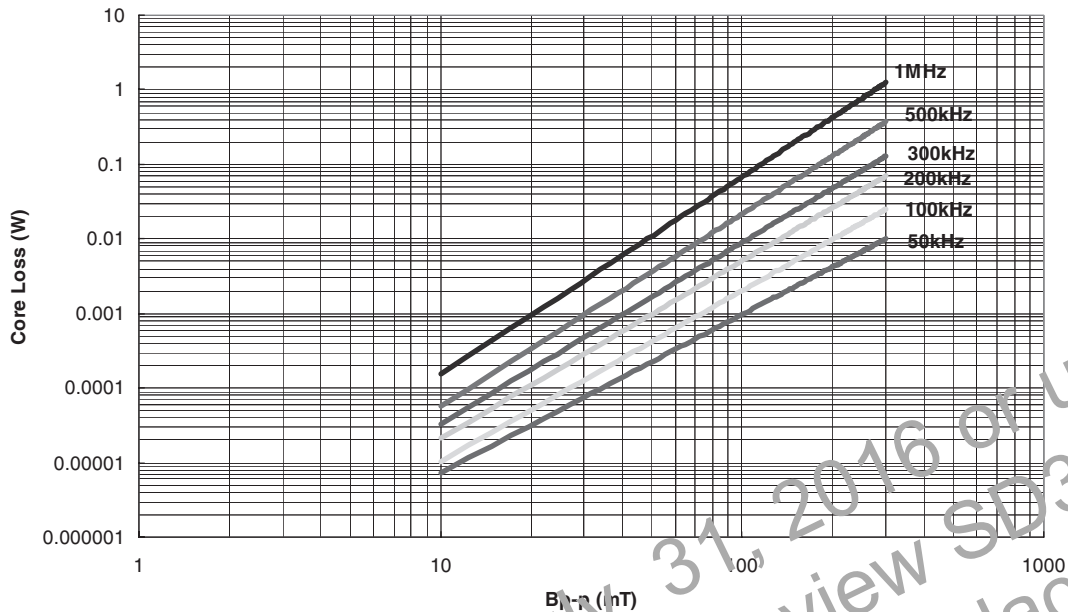


Parts packaged on 13" Diameter reel,  
4,100 parts per reel.

### DC Current vs. Temperature



### Core Loss



### Inductance Characteristics

